

Electronic Acknowledgement Receipt

EFS ID:	1068523
Application Number:	10797425
Confirmation Number:	4397
Title of Invention:	Silicon-germanium thin layer semiconductor structure with variable silicon-germanium composition and method of fabrication
First Named Inventor:	Pradip K. Roy
Customer Number:	37694
Filer:	Kristi Lynn Davidson/Geena Licata
Filer Authorized By:	Kristi Lynn Davidson
Attorney Docket Number:	TPS-008
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1		Response_FinalOA.pdf	708845	yes	15

	Multipart Description		
	Doc Desc	Start	End
	Amendment After Final	1	1
	Claims	2	9
	Applicant Arguments/Remarks Made in an Amendment	10	15

Warnings:

Information:

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New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.